

# **General Purpose Transistors**

**PNP Silicon** 

# BC807-25W, BC807-40W

#### **Features**

- S Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

### **MAXIMUM RATINGS**

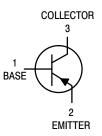
Rating	Symbol	Value	Unit
Collector - Emitter Voltage	V <sub>CEO</sub>	-45	V
Collector - Base Voltage	V <sub>CBO</sub>	-50	V
Emitter – Base Voltage	V <sub>EBO</sub>	-5.0	V
Collector Current – Continuous	Ic	-500	mAdc

### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation FR-5 Board, (Note 1) T <sub>A</sub> = 25°C	P <sub>D</sub>	460	mW
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	272	°C/W
Junction and Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. FR-4 Board, 1 oz. Cu, 100 mm<sup>2</sup>.





SC-70 CASE 419 STYLE 3

### **MARKING DIAGRAM**



5x = Device Code x = B or C

M = Date Code\*= Pb-Free Package

(Note: Microdot may be in either location)

\*Date Code orientation and/or overbar may vary depending upon manufacturing location.

#### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

### **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise noted.)

Characteristic	Symbol	Min	Тур	Max	Unit	
OFF CHARACTERISTICS						
Collector – Emitter Breakdown Voltage $(I_C = -10 \text{ mA})$		V <sub>(BR)CEO</sub>	-45	-	-	V
Collector – Emitter Breakdown Voltage $(V_{EB}=0,I_C=-10\mu\text{A})$		V <sub>(BR)CES</sub>	-50	_	_	V
Emitter – Base Breakdown Voltage $(I_E = -1.0 \mu A)$		V <sub>(BR)EBO</sub>	-5.0	-	_	V
Collector Cutoff Current $(V_{CB} = -20 \text{ V})$ $(V_{CB} = -20 \text{ V}, T_{J} = 150^{\circ}\text{C})$		Ісво	- -	- -	-100 -5.0	nA μA
ON CHARACTERISTICS						
DC Current Gain $(I_C = -100 \text{ mA}, V_{CE} = -1.0 \text{ V})$ $(I_C = -500 \text{ mA}, V_{CE} = -1.0 \text{ V})$	BC807-25, SBC807-25 BC807-40, SBC807-40	h <sub>FE</sub>	160 250 40	- - -	400 600 –	-
Collector – Emitter Saturation Voltage (I <sub>C</sub> = -500 mA, I <sub>B</sub> = -50 mA)		V <sub>CE(sat)</sub>	-	-	-0.7	V
Base – Emitter On Voltage (I <sub>C</sub> = -500 mA, V <sub>CE</sub> = -1.0 V)		V <sub>BE(on)</sub>	-	=	-1.2	V
SMALL-SIGNAL CHARACTERISTICS			-		-	
Current – Gain – Bandwidth Product (I <sub>C</sub> = -10 mA, V <sub>CE</sub> = -5.0 Vdc, f = 100 MHz)		f <sub>T</sub>	100	-	-	MHz
Output Capacitance (V <sub>CB</sub> = -10 V, f = 1.0 MHz)		C <sub>obo</sub>	-	10	_	pF

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

### **ORDERING INFORMATION**

Device	Specific Marking	Package	Shipping <sup>†</sup>	
BC807-25WT1G			2000 / Tana & Baal	
SBC807-25WT1G*	5B	SC-70 (Pb-Free)	3000 / Tape & Reel	
BC807-25WT3G		,	10,000 / Tape & Reel	
BC807-40WT1G			0000 / Tana & Baal	
SBC807-40WT1G*	5C	SC-70 (Pb-Free)	3000 / Tape & Reel	
BC807-40WT3G		( 12-)	10,000 / Tape & Reel	

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

<sup>\*</sup>S Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable.

### TYPICAL CHARACTERISTICS - BC807-25W, SBC807-25W

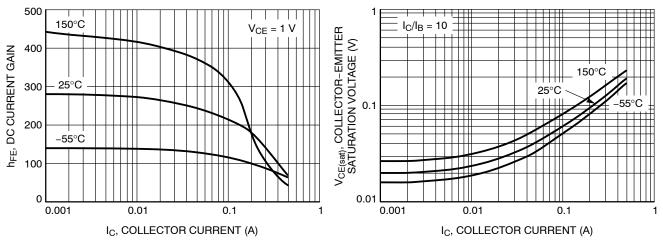


Figure 1. DC Current Gain vs. Collector Current

Figure 2. Collector Emitter Saturation Voltage vs. Collector Current

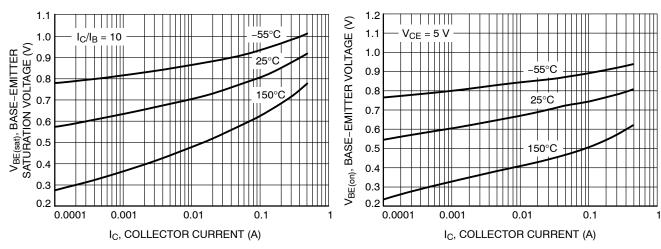


Figure 3. Base Emitter Saturation Voltage vs. Collector Current

Figure 4. Base Emitter Voltage vs. Collector Current

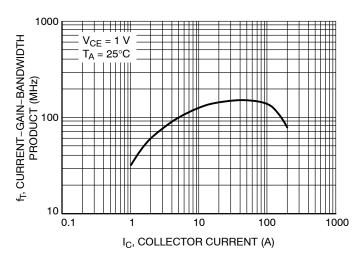


Figure 5. Current Gain Bandwidth Product vs.
Collector Current

# TYPICAL CHARACTERISTICS - BC807-25W, SBC807-25W

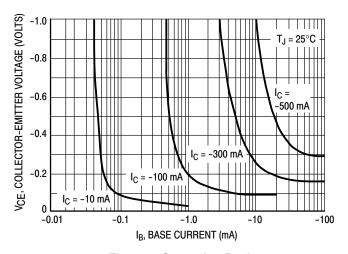


Figure 6. Saturation Region

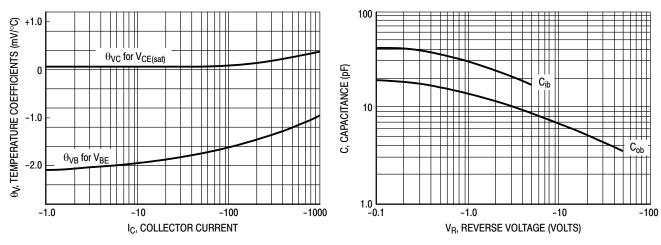


Figure 7. Temperature Coefficients

Figure 8. Capacitances

### TYPICAL CHARACTERISTICS - BC807-40W, SBC807-40W

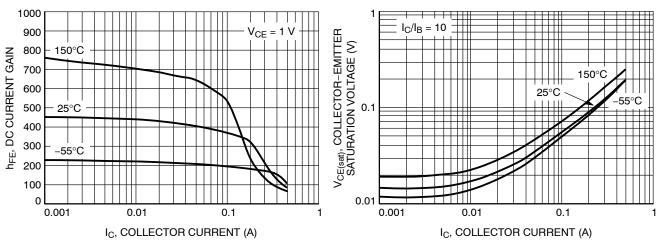


Figure 9. DC Current Gain vs. Collector Current

Figure 10. Collector Emitter Saturation Voltage vs. Collector Current

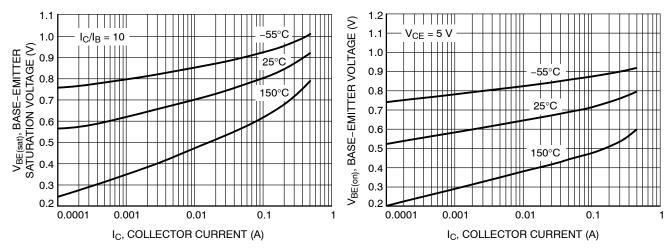


Figure 11. Base Emitter Saturation Voltage vs. Collector Current

Figure 12. Base Emitter Voltage vs. Collector Current

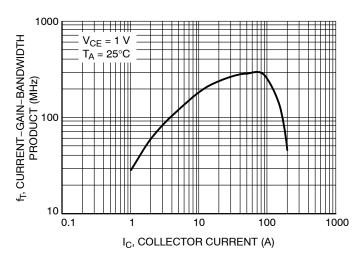


Figure 13. Current Gain Bandwidth Product vs. Collector Current

# TYPICAL CHARACTERISTICS - BC807-40W, SBC807-40W

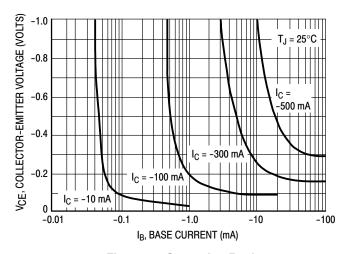


Figure 14. Saturation Region

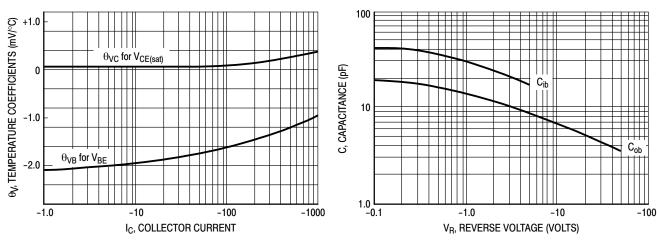


Figure 15. Temperature Coefficients

Figure 16. Capacitances

## **TYPICAL CHARACTERISTICS - BC807-25W, SBC807-25W, BC807-40W, SBC807-40W**

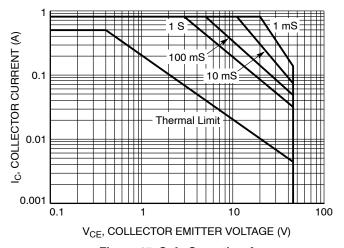


Figure 17. Safe Operating Area

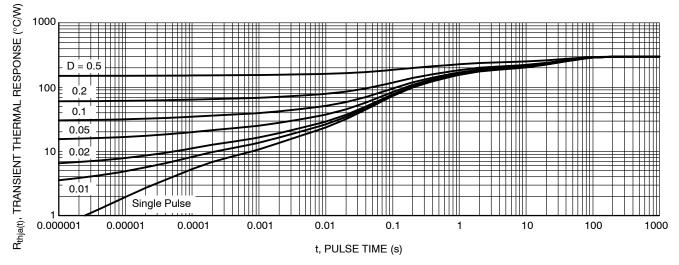


Figure 18. Thermal Response





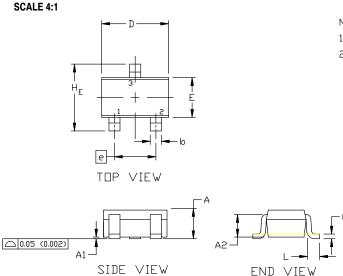
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**DATE 11 OCT 2022** 

#### NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: INCH

	MILLIMETERS				INCHES		
DIM	MIN.	N□M.	MAX.	MIN.	N□M.	MAX.	
Α	0.80	0.90	1.00	0.032	0.035	0.040	
A1	0.00	0.05	0.10	0.000	0.002	0.004	
A2		0.70 REF			0.028 BSC		
b	0.30	0.35	0.40	0.012	0.014	0.016	
С	0.10	0.18	0.25	0.004	0.007	0.010	
D	1.80	2.00	2.20	0.071	0.080	0.087	
E	1.15	1.24	1.35	0.045	0.049	0.053	
е	1.20	1.30	1.40	0.047	0.051	0.055	
e1	0.65 BSC				0.026 BS	C	
L	0.20	0.38	0.56	0.008	0.015	0.022	
HE	2.00	2.10	2.40	0.079	0.083	0.095	



### **GENERIC MARKING DIAGRAM**

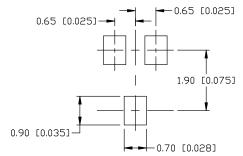


XX = Specific Device Code

Μ = Date Code

= Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.



For additional information on our Pb-Free strategy and soldering details, please download the IN Semiconductor Soldering and Mounting Techniques Reference Manual, SILDERRM/D.

SOLDERING FOOTPRINT

STYLE 1: CANCELLED	STYLE 2: PIN 1. ANODE 2. N.C. 3. CATHODE	STYLE 3: PIN 1. BASE 2. EMITTER 3. COLLECTOR	STYLE 4: PIN 1. CATHODE 2. CATHODE 3. ANODE	STYLE 5: PIN 1. ANODE 2. ANODE 3. CATHODE	
STYLE 6:	STYLE 7:	STYLE 8:	STYLE 9:	STYLE 10:	STYLE 11:
PIN 1. EMITTER	PIN 1. BASE	PIN 1. GATE	PIN 1. ANODE	PIN 1. CATHODE	PIN 1. CATHODE
2. BASE	2. EMITTER	2. SOURCE	2. CATHODE	2. ANODE	<ol><li>CATHODE</li></ol>
<ol><li>COLLECTOR</li></ol>	<ol><li>COLLECTOR</li></ol>	3. DRAIN	<ol><li>CATHODE-ANODE</li></ol>	3. ANODE-CATHODE	<ol><li>CATHODE</li></ol>

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